General Purpose Transistor

NPN Silicon

• Moisture Sensitivity Level: 1

• ESD Rating: Human Body Model – 4 kV

Machine Model - 400 V

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	40	Vdc
Collector-Base Voltage	V _{CBO}	75	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current – Continuous	I _C	600	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Package Dissipation (Note 1) T _A = 25°C	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

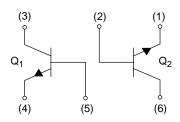
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

 Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.



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SC-88/SC70-6/SOT-363 CASE 419B STYLE 1

MARKING DIAGRAM



1P = Specific Device Code D = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
MBT2222ADW1T1	SOT-363	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS			I	
Collector–Emitter Breakdown Voltage $(I_C = 10 \text{ mAdc}, I_B = 0)$	V _{(BR)CEO}	40	_	Vdc
Collector–Base Breakdown Voltage $(I_C = 10 \mu Adc, I_E = 0)$	V _{(BR)CBO}	75	-	Vdc
Emitter–Base Breakdown Voltage ($I_E = 10 \mu Adc, I_C = 0$)	V _{(BR)EBO}	6.0	_	Vdc
Collector Cutoff Current $(V_{CE} = 60 \text{ Vdc}, V_{EB(off)} = 3.0 \text{ Vdc})$	I _{CEX}	_	10	nAdc
Collector Cutoff Current $(V_{CB} = 60 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 60 \text{ Vdc}, I_E = 0, T_A = 125^{\circ}\text{C})$	I _{CBO}	-	0.01 10	μAdc
Emitter Cutoff Current $(V_{EB} = 3.0 \text{ Vdc}, I_{C} = 0)$	I _{EBO}	-	100	nAdc
Base Cutoff Current $(V_{CE} = 60 \text{ Vdc}, V_{EB(off)} = 3.0 \text{ Vdc})$	I _{BL}	-	20	nAdc
ON CHARACTERISTICS				
DC Current Gain	h _{FE}	35 50 75 35 100 50 40	- - - 300 - -	-
Collector–Emitter Saturation Voltage (Note 2) (I_C = 150 mAdc, I_B = 15 mAdc) (I_C = 500 mAdc, I_B = 50 mAdc)	V _{CE(sat)}	- -	0.3 1.0	Vdc
Base-Emitter Saturation Voltage (Note 2) ($I_C = 150 \text{ mAdc}$, $I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 50 \text{ mAdc}$)	V _{BE(sat)}	0.6	1.2 2.0	Vdc

^{2.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)

Characteristic			Min	Max	Unit
SMALL-SIGNAL CHARACTERISTICS		-	•	•	•
Current-Gain - Bandwidth Product (Note 3) (I _C = 20 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)		f _T	300	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)			_	8.0	pF
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MH	Hz)	C _{ibo}	_	25	pF
Input Impedance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$) ($I_C = 10 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)			2.0 0.25	8.0 1.25	kΩ
Voltage Feedback Ratio $ \begin{array}{l} \text{(I}_{C} = 1.0 \text{ mAdc, V}_{CE} = 10 \text{ Vdc, f} = 1.0 \text{ kHz)} \\ \text{(I}_{C} = 10 \text{ mAdc, V}_{CE} = 10 \text{ Vdc, f} = 1.0 \text{ kHz)} \end{array} $			- -	8.0 4.0	X 10 ⁻⁴
Small–Signal Current Gain		h _{fe}	50 75	300 375	_
Output Admittance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$) ($I_C = 10 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)			5.0 25	35 200	μmhos
Collector Base Time Constant (I _E = 20 mAdc, V _{CB} = 20 Vdc, f = 31.8 MHz)			_	150	ps
Noise Figure (I _C = 100 μ Adc, V _{CE} = 10 Vdc, R _S = 1.0 k Ω , f = 1.0 kHz)			_	4.0	dB
SWITCHING CHARACTERISTICS					
Delay Time	(V _{CC} = 30 Vdc, V _{BE(off)} = -0.5 Vdc,	t _d	_	10	
Rise Time	I _C = 150 mAdc, I _{B1} = 15 mAdc)	t _r	-	25	ns
Storage Time	(V _{CC} = 30 Vdc, I _C = 150 mAdc,	t _s	_	225	
Fall Time	$I_{B1} = I_{B2} = 15 \text{ mAdc}$	t _f	_	60	ns

^{3.} f_T is defined as the frequency at which |h_{fe}| extrapolates to unity.

SWITCHING TIME EQUIVALENT TEST CIRCUITS

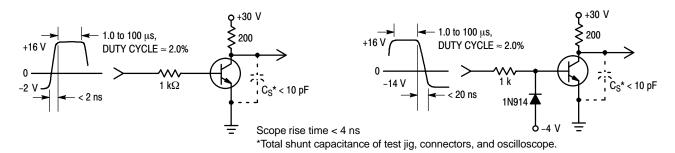


Figure 1. Turn-On Time

Figure 2. Turn-Off Time

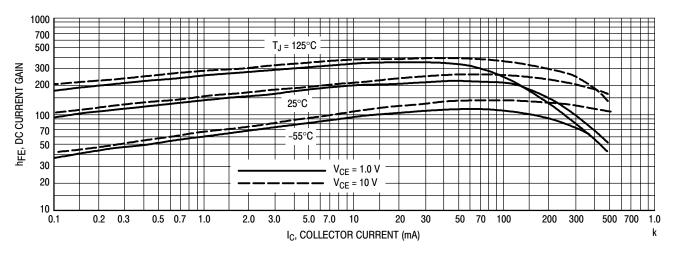


Figure 3. DC Current Gain

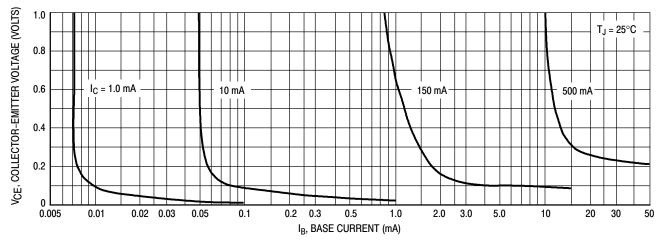
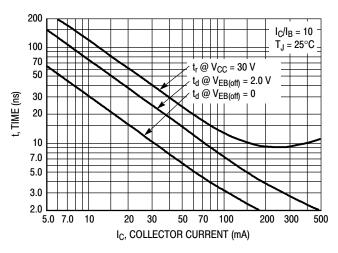


Figure 4. Collector Saturation Region

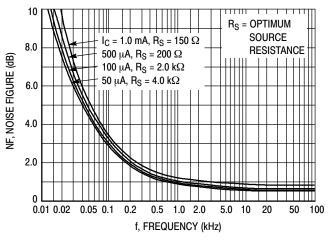
500



 $V_{CC} = 30 \text{ V}$ 300 $I_C/I_B = 10$ $t'_{s} = t_{s} - 1/8 t_{f}$ 200 $I_{B1} = I_{B2}$ $T_J = 25^{\circ}C$ 100 t, TIME (ns) 70 50 30 20 10 7.0 5.0 5.0 7.0 10 50 70 100 200 300 500 IC, COLLECTOR CURRENT (mA)

Figure 5. Turn-On Time

Figure 6. Turn-Off Time



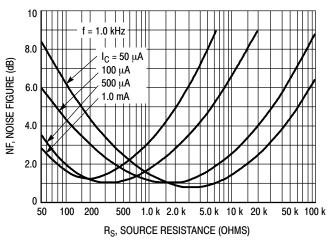
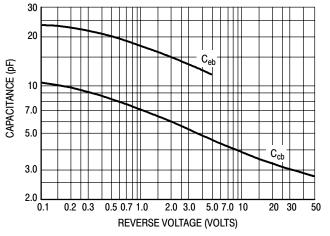


Figure 7. Frequency Effects

Figure 8. Source Resistance Effects



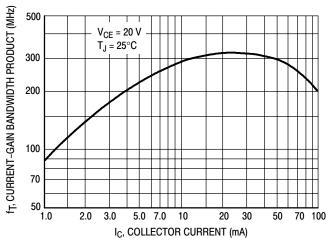
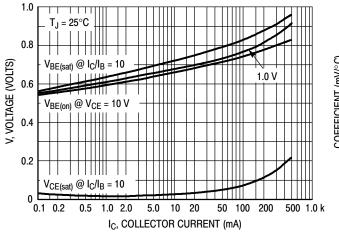
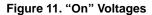


Figure 9. Capacitances

Figure 10. Current-Gain Bandwidth Product





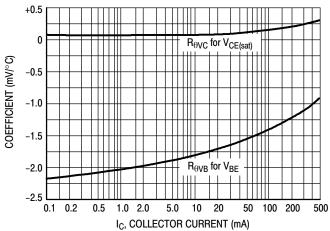
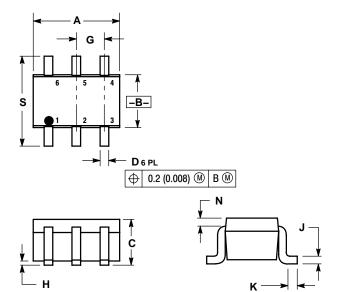


Figure 12. Temperature Coefficients

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363

CASE 419B-02 ISSUE 02U

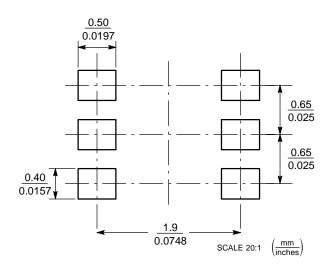


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	INCHES		MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.071	0.087	1.80	2.20		
В	0.045	0.053	1.15	1.35		
С	0.031	0.043	0.80	1.10		
D	0.004	0.012	0.10	0.30		
G	0.026	BSC	0.65	BSC		
Н		0.004		0.10		
J	0.004	0.010	0.10	0.25		
K	0.004	0.012	0.10	0.30		
N	0.008 REF		0.20	REF		
S	0.079	0.087	2.00	2.20		

- STYLE 1:
 PIN 1. EMITTER 2
 2. BASE 2
 3. COLLECTOR 1
 4. EMITTER 1
 5. BASE 1
 6. COLLECTOR 2

SOLDERING FOOTPRINT



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